

# Artificial Intelligence and Machine Learning in Printed Electronics Design



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## Why we are doing this project

- This project aims to improve the precision and predictability of printed electronics via a combination of feature-based and image-based machine learning models for an AI optimization scheme acting upon various printing process parameters.
- By using AI and machine learning, we can optimize the accuracy of printed electronics, thus reducing the waste caused by actual experiments while boosting the efficiency and versatility of the technology.
- By using the actual test data, we can train the machine learning model to input the lithography and output the actual electrical characteristics of the printed device.

## How we obtain the dataset

- We design mask and use it to print resistors with different parameters on NanoDimension DragonFly IV 3D printer.

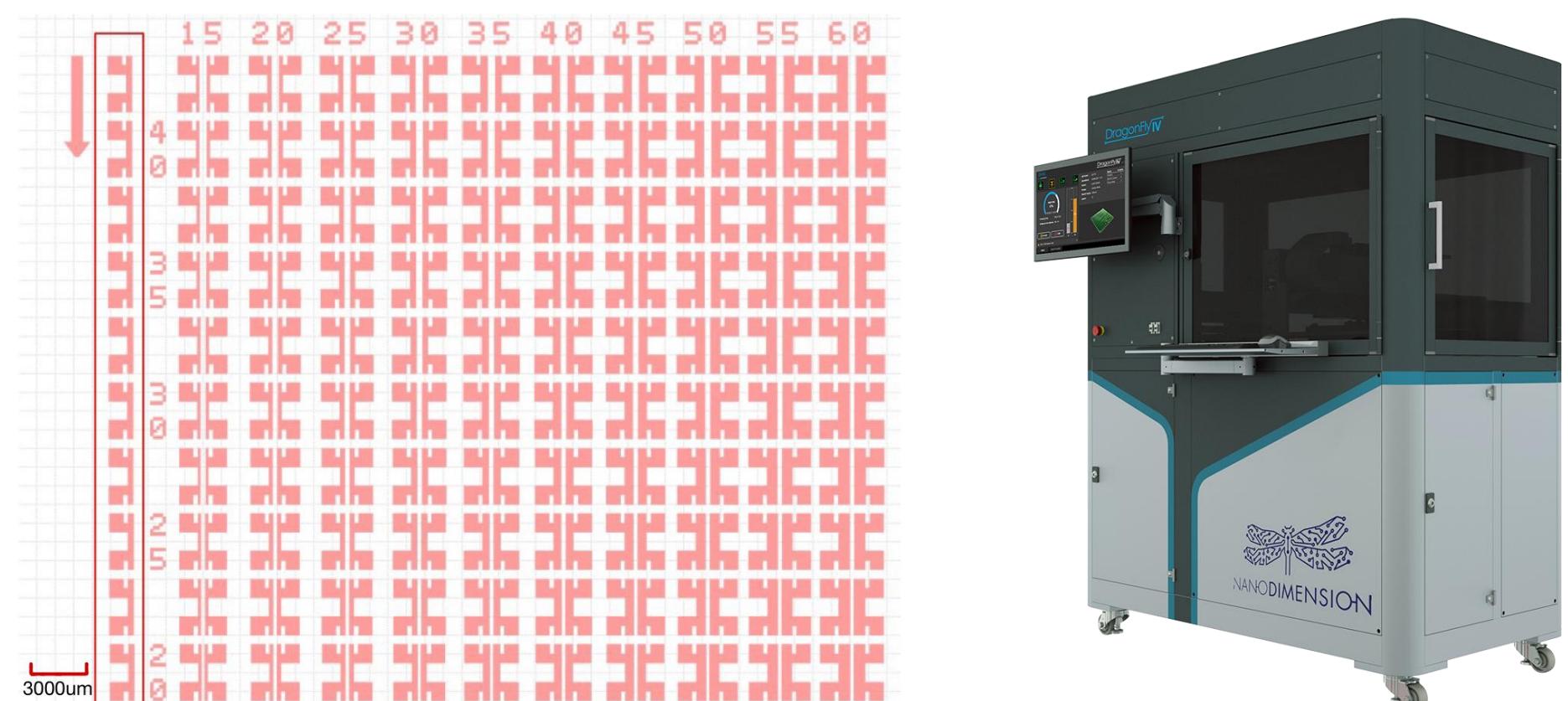


Figure: (Left) Layout of printed resistor pairs for testing; (Right) DragonFly IV 3D printer used for fabrication.

- In printed electronics fabrication, R2 data modeling focuses on two key printer parameters: Dynamic Top Oven (DTO) speed (0 mm/s, 200 mm/s, 400 mm/s) and Tray Temperature (120°C, 160°C, 175°C) during the drying phase.

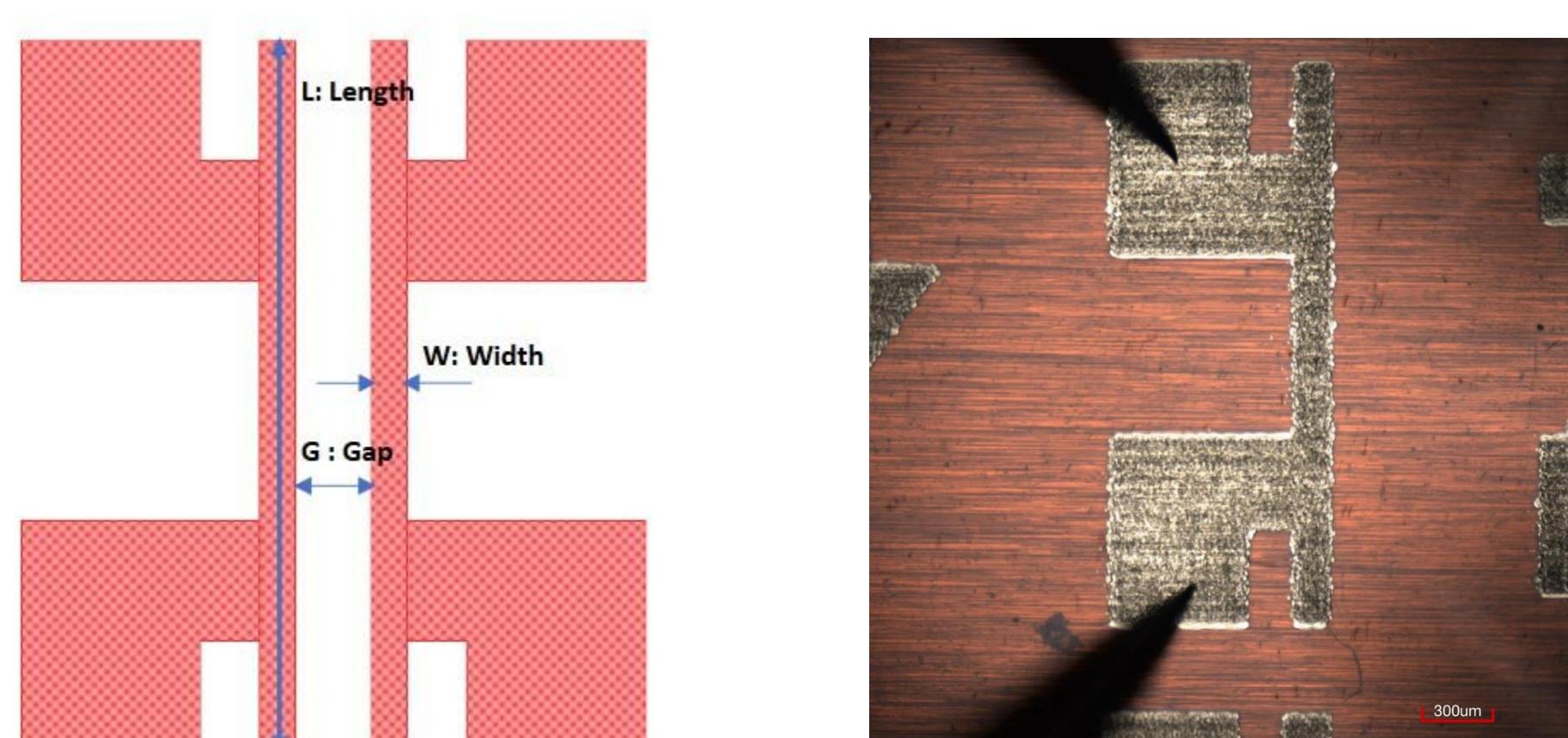


Figure: (Left) Schematic of unit resistor pair showing length (L), width (W), and gap (G); (Right) Image of physical printed resistor under four-probe measurement.

- Measurement Procedure:** Record both target and measured widths/gaps. Then, perform four-probe measurements to obtain voltage and current, from which resistance and conductance are calculated.

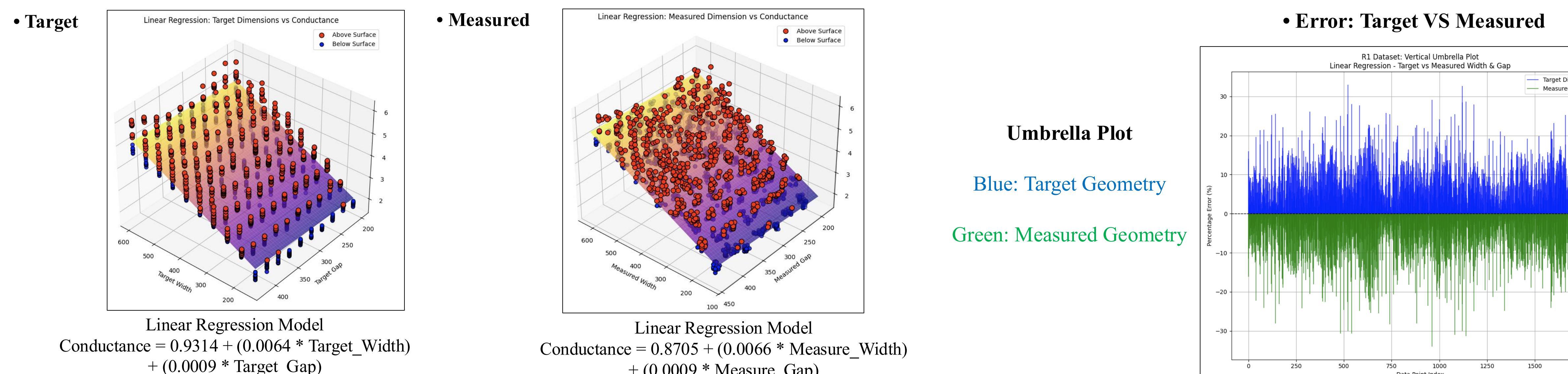
## Acknowledgement

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## Training Process and Results of R1 Model

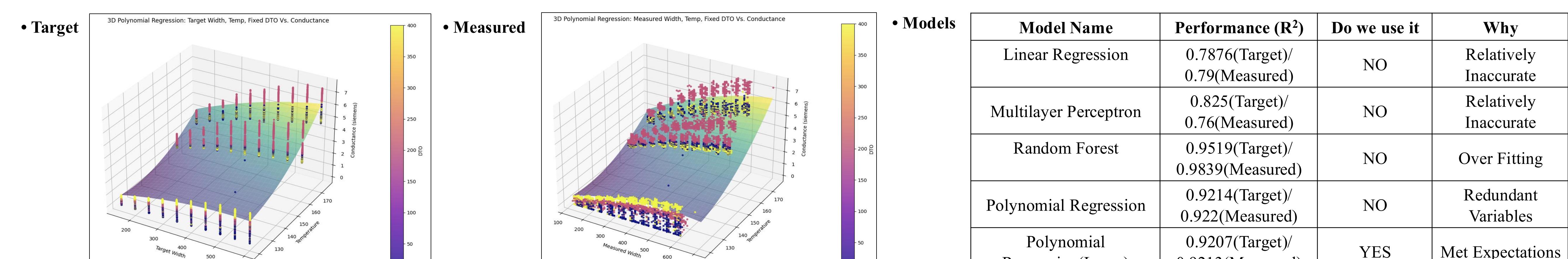
- Model Setup:** The R1 model used width and gap as input features, including both target layout values and actual measured values.
- Output Variable:** The model was trained to predict the electrical behavior. Specifically, conductance was measured to evaluate how easily current flows through the structure.
- Model Exploration:** Various modeling techniques were tested to determine the most accurate fit for the conductance data. This includes Linear Regression, Random Forest, and Multilayer Perceptron.
- Motivations:** (1) Identify the most accurate model; (2) Test the expected linear relationship between conductance and width.
- Key Result:** Linear regression outperformed all other models, showing a strong fit and confirming a linear pattern. This is consistent with the expected linear relationship.
- Input Accuracy:** Compared errors from target vs. measured inputs to evaluate their impact on model performance. The umbrella plots show no significant error patterns.

Models	Model Name	Performance ( $R^2$ )	Do we use it	Why
	Multilayer Perceptron	0.9056(Target)/ 0.90054(Measured)	NO	Over fitting
	Random Forest	0.9120(Target)/ 0.95112(Measured)	NO	Over fitting
	Linear Regression	0.8844(Target)/ 0.88079(Measured)	YES	Met expectations



## Training Process and Results of R2 Model

- For the R2 model, expanded input features: Incorporated width, gap, DTO, and temperature as additional inputs; both target and measured values for width and gap were included to enrich the dataset.
- Model Evaluation:** Tested multiple machine learning approaches (Linear Regression, Polynomial Regression, etc.), and polynomial regression delivered the highest predictive accuracy for conductance.
- Model Optimization with Least Absolute Shrinkage and Selection Operator (LASSO):** Observed redundancy in polynomial terms; applied input scaling and LASSO regression enhance interpretability.
- Input Source Comparison:** Compared model prediction errors when using target vs. measured input values to evaluate their impact on model performance.



$$\text{Conductance} = 2.8059 + 0.7041 * \text{Target\_Width} + 0.0128 * \text{Target\_Gap} + 1.5406 * \text{Temp} + 0.0904 * \text{DTO} - 0.1281 * \text{Target\_Width}^2 + 0.2565 * \text{Target\_Width} * \text{Temp} + 0.0207 * \text{Target\_Width} * \text{DTO} + 0.0097 * \text{Target\_Gap} * \text{Temp} + 0.5242 * \text{Temp}^2 - 0.1569 * \text{Temp} * \text{DTO} - 0.4830 * \text{DTO}^2$$

$$\text{Conductance} = 2.8017 + 0.7048 * \text{Measure\_Width} + 0.0123 * \text{Measure\_Gap} + 1.5678 * \text{Temp} + 0.0914 * \text{DTO} - 0.1287 * \text{Measure\_Width}^2 + 0.2490 * \text{Measure\_Width} * \text{Temp} + 0.0212 * \text{Measure\_Width} * \text{DTO} + 0.5304 * \text{Temp}^2 - 0.1570 * \text{Temp} * \text{DTO} - 0.4727 * \text{DTO}^2$$

